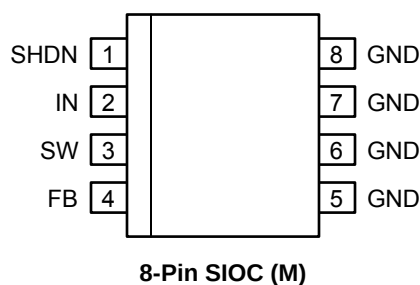


Ordering Information

Part Number		Voltage	Junction Temp. Range	Package
Standard	Pb-Free			
MIC4680BM	MIC4680YM	Adj.	−40°C to +125°C	8-Pin SOIC
MIC4680-3.3BM	MIC4680-3.3YM	3.3V	−40°C to +125°C	8-Pin SOIC
MIC4680-5.0BM	MIC4680-5.0YM	5.0V	−40°C to +125°C	8-Pin SOIC

Pin Configuration



Pin Description

Pin Number	Pin Name	Pin Function
1	SHDN	Shutdown (Input): Logic low enables regulator. Logic high (>1.6V) shuts down regulator.
2	VIN	Supply Voltage (Input): Unregulated +4V to +34V supply voltage.
3	SW	Switch (Output): Emitter of NPN output switch. Connect to external storage inductor and Schottky diode.
4	FB	Feedback (Input): Connect to output on fixed output voltage versions, or to 1.23V-tap of voltage-divider network for adjustable version.
5 – 8	GND	Ground

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V_{IN}) ⁽³⁾	+38V
Shutdown Voltage (V_{SHDN})	−0.3V to +38V
Steady-State Output Switch Voltage (V_{SW})	−1V
Feedback Voltage [Adjustable] (V_{FB})	+12V
Storage Temperature (T_s)	−65°C to +150°C
EDS Rating ⁽⁵⁾	

Operating Ratings⁽²⁾

Supply voltage (V_{IN}) ⁽⁴⁾	+4V to +34V
Junction Temperature (T_J)	+125°C
Package Thermal Resistance ⁽⁶⁾	
SIOC (θ_{JA})	63°C/W

Electrical Characteristics

$V_{IN} = 12V$; $I_{LOAD} = 500mA$; $T_J = 25^\circ C$, **bold** values indicate $-40^\circ C \leq T_J \leq +125^\circ C$, **Note 7**; unless noted.

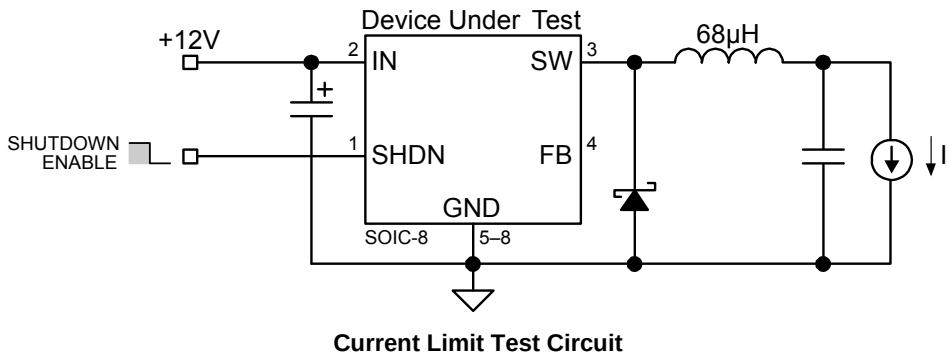
Parameter	Condition	Min	Typ	Max	Units
MIC4680 [Adjustable]					
Feedback Voltage	($\pm 1\%$)	1.217	1.230	1.243	V
	($\pm 1\%$)	1.205		1.255	V
	$8V \leq V_{IN} \leq 34V$, $0.1A \leq I_{LOAD} \leq 1A$, $V_{OUT} = 5V$	1.193	1.230	1.267	V
		1.180		1.280	V
Maximum Duty Cycle	$V_{FB} = 1.0V$	93	97		%
Output Leakage Current	$V_{IN} = 34V$, $V_{SHDN} = 5V$, $V_{SW} = 0V$		50	500	μA
	$V_{IN} = 34V$, $V_{SHDN} = 5V$, $V_{SW} = -1V$		4	20	mA
Quiescent Current	$V_{FB} = 1.5V$		7	12	mA
MIC4680-3.3					
Output Voltage	($\pm 1\%$)	3.266	3.3	3.333	V
	($\pm 3\%$)	3.201		3.399	V
	$6V \leq V_{IN} \leq 34V$, $0.1A \leq I_{LOAD} \leq 1A$	3.168	3.3	3.432	V
		3.135		3.465	V
Maximum Duty Cycle	$V_{FB} = 2.5V$	93	97		%
Output Leakage Current	$V_{IN} = 34V$, $V_{SHDN} = 5V$, $V_{SW} = 0V$		50	500	μA
	$V_{IN} = 34V$, $V_{SHDN} = 5V$, $V_{SW} = -1V$		4	20	mA
Quiescent Current	$V_{FB} = 4.0V$		7	12	mA
MIC4680-5.0					
Output Voltage	($\pm 1\%$)	4.950	5.0	5.05	V
	($\pm 3\%$)	4.85		5.15	V
	$8V \leq V_{IN} \leq 34V$, $0.1A \leq I_{LOAD} \leq 1A$	4.800	5.0	5.200	V
		4.750		5.250	V
Maximum Duty Cycle	$V_{FB} = 4.0V$	93	97		%
Output Leakage Current	$V_{IN} = 34V$, $V_{SHDN} = 5V$, $V_{SW} = 0V$		50	500	μA
	$V_{IN} = 34V$, $V_{SHDN} = 5V$, $V_{SW} = -1V$		4	20	mA
Quiescent Current	$V_{FB} = 6.0V$		7	12	mA
MIC4680/-3.3/-5.0					
Frequency Fold Back		30	50	100	kHz
Oscillator Frequency		180	200	220	kHz
Saturation Voltage	$I_{OUT} = 1A$		1.4	1.8	V
Short Circuit Current Limit	$V_{FB} = 0V$, see Test Circuit	1.3	1.8	2.5	A
Standby Quiescent Current	$V_{SHDN} = V_{IN}$		1.5		μA
	$V_{SHDN} = 5V$ (regulator off)		30	100	μA

Parameter	Condition	Min	Typ	Max	Units
Shutdown Input Logic Level	regulator off	2	1.6		V
	regulator on		1.0	0.8	V
Shutdown Input Current	$V_{SHDN} = 5V$ (regulator off)	-10	-0.5	10	μA
	$V_{SHDN} = 0V$ (regulator on)	-10	-1.5	10	μA
Thermal Shutdown			160		$^{\circ}C$

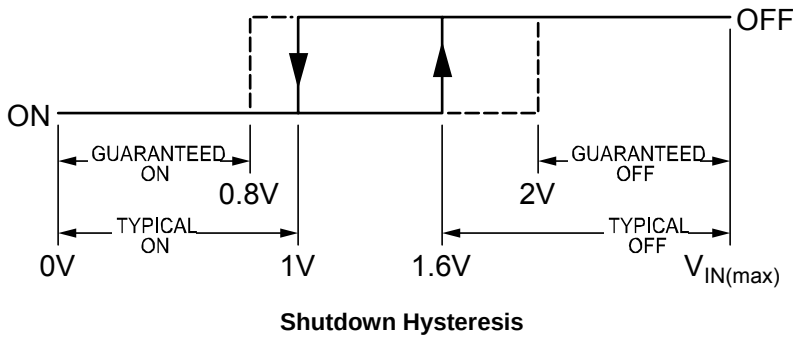
Notes:

- 1. Exceeding the absolute maximum rating may damage the device.
- 2. The device is not guaranteed to function outside its operating rating.
- 3. Absolute maximum rating is intended for voltage transients only, prolonged dc operation is not recommended.
- 4. $V_{IN(min)} = V_{OUT} + 2.5V$ or $4V$ whichever is greater.
- 5. Devices are ESD sensitive. Handling precautions recommended.
- 6. Measured on 1" square of 1 oz. copper FR4 printed circuit board connected to the device ground leads.
- 7. Test at $T_A = +85^{\circ}C$, guaranteed by design, and characterized to $T_J = +125^{\circ}C$.

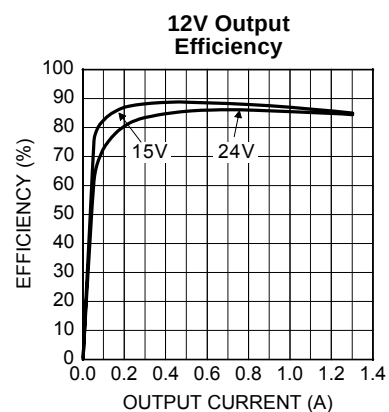
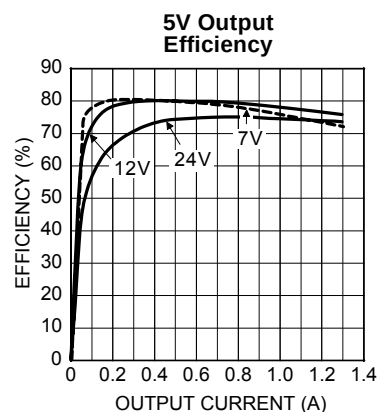
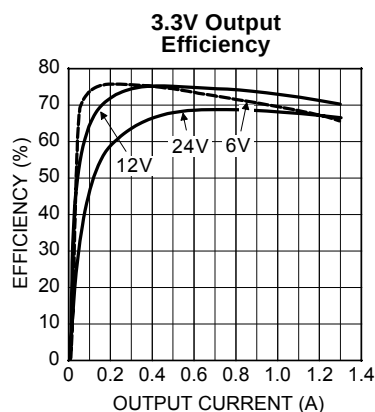
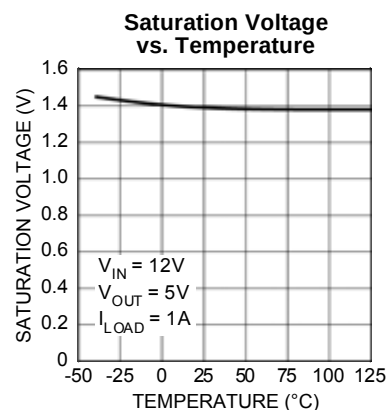
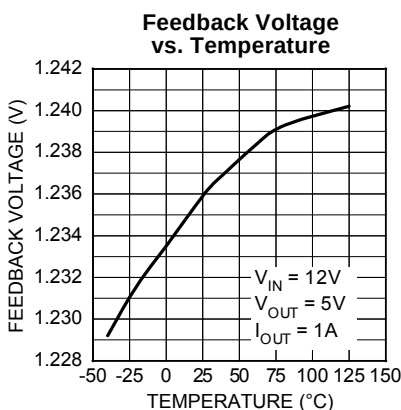
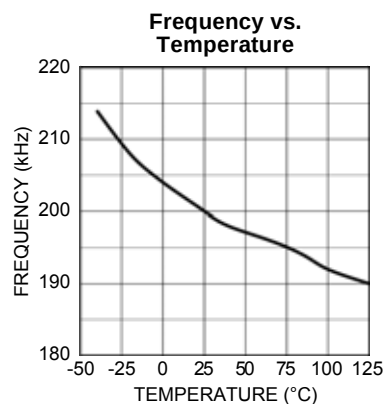
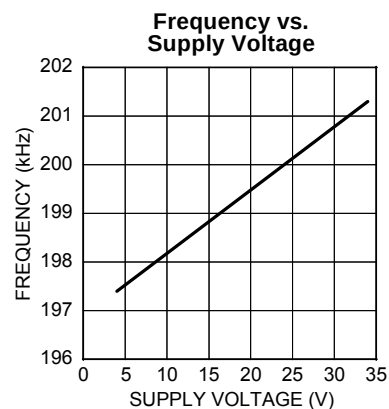
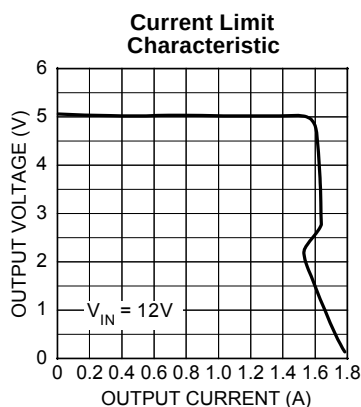
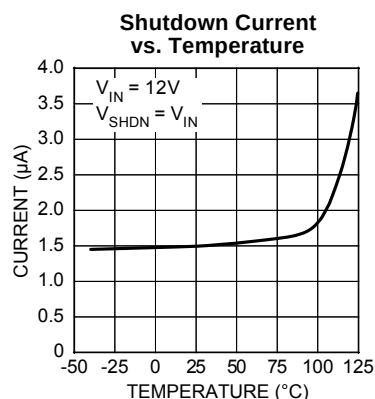
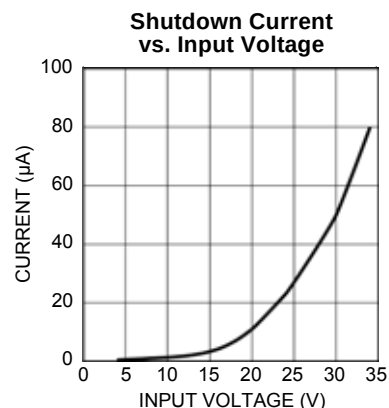
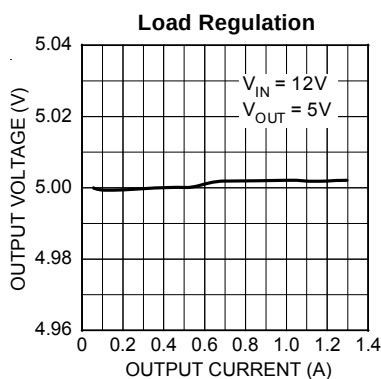
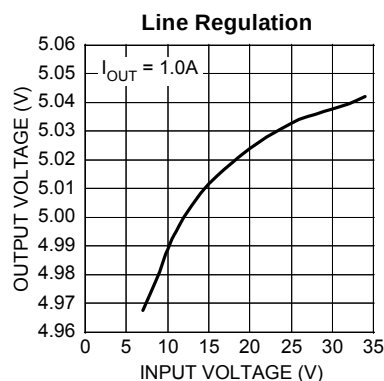
Test Circuit

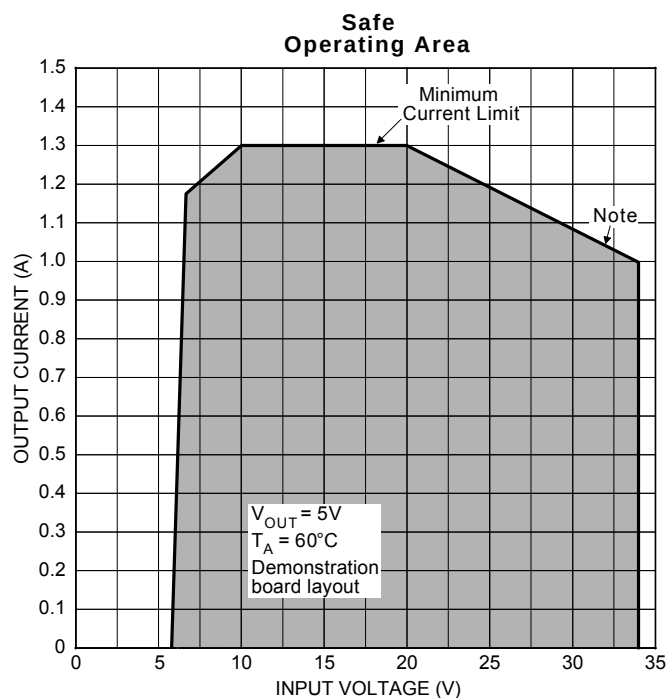


Shutdown Input Behavior

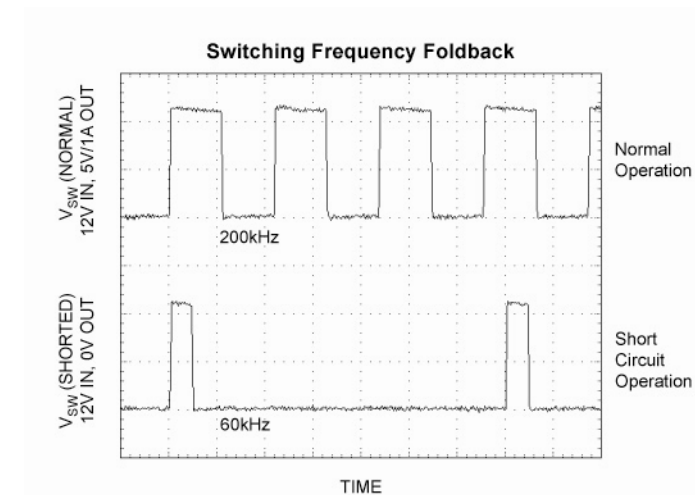


Typical Characteristics



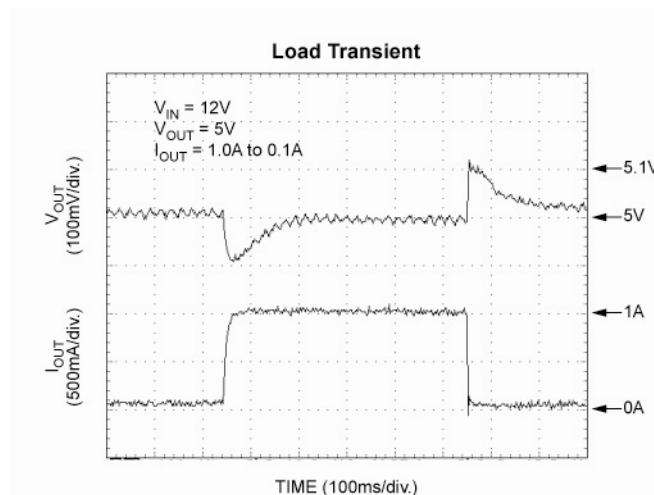


Functional Characteristics



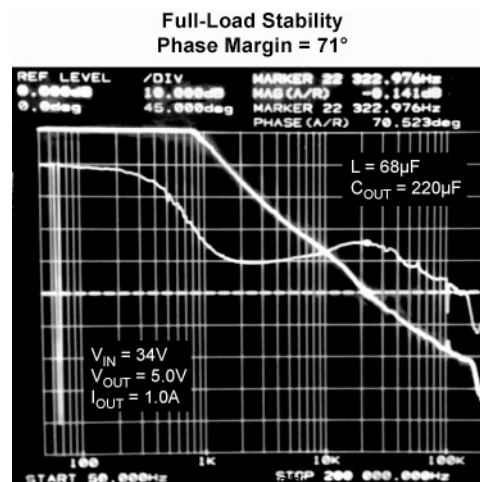
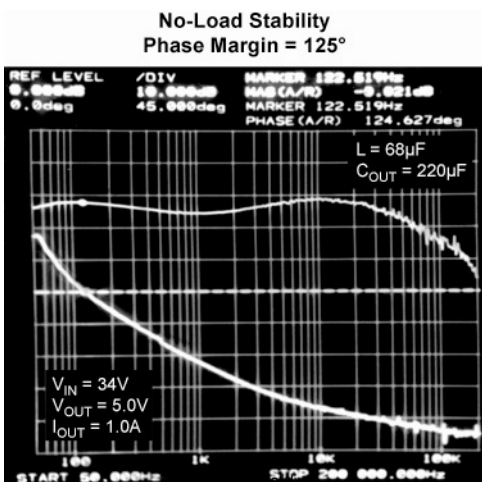
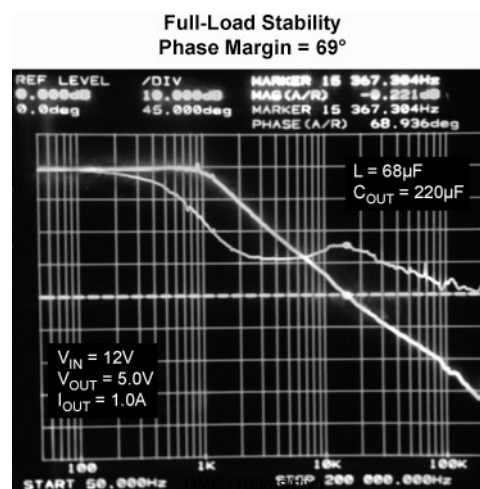
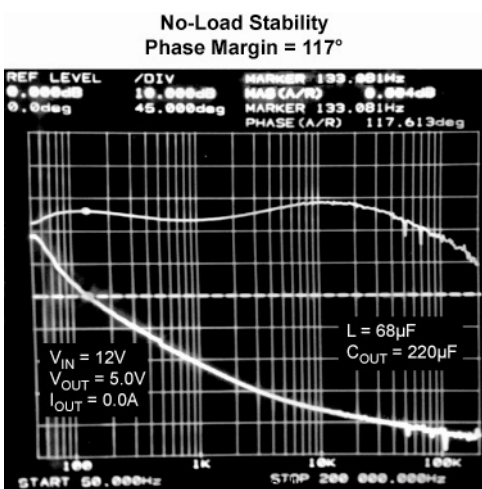
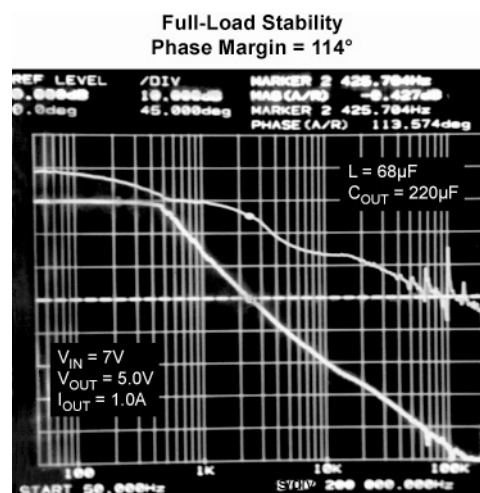
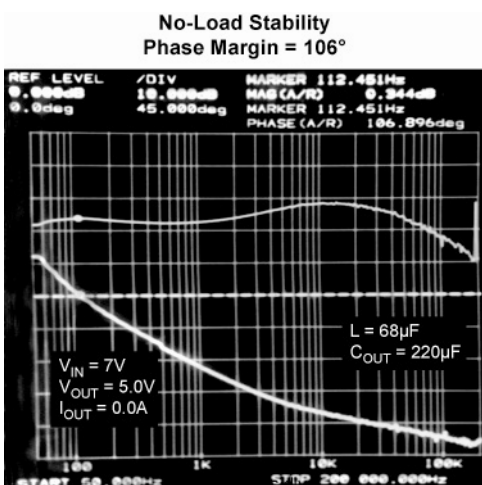
Frequency Foldback

The MIC4680 folds the switching frequency back during a hard short-circuit condition to reduce the energy per cycle and protect the device.

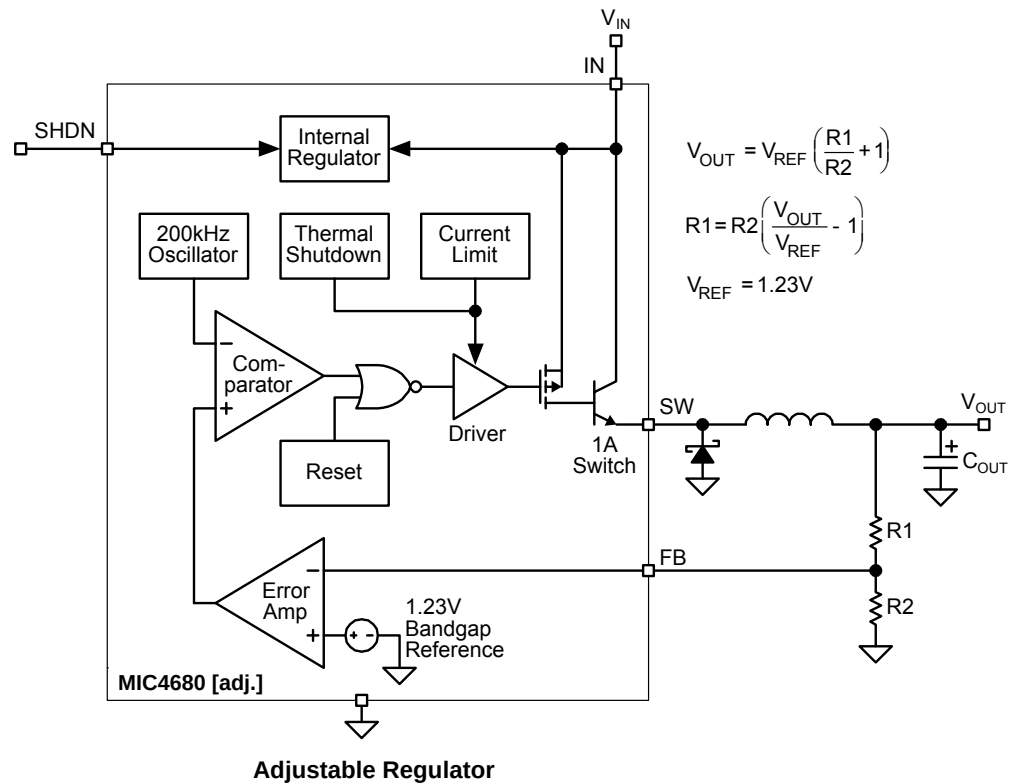
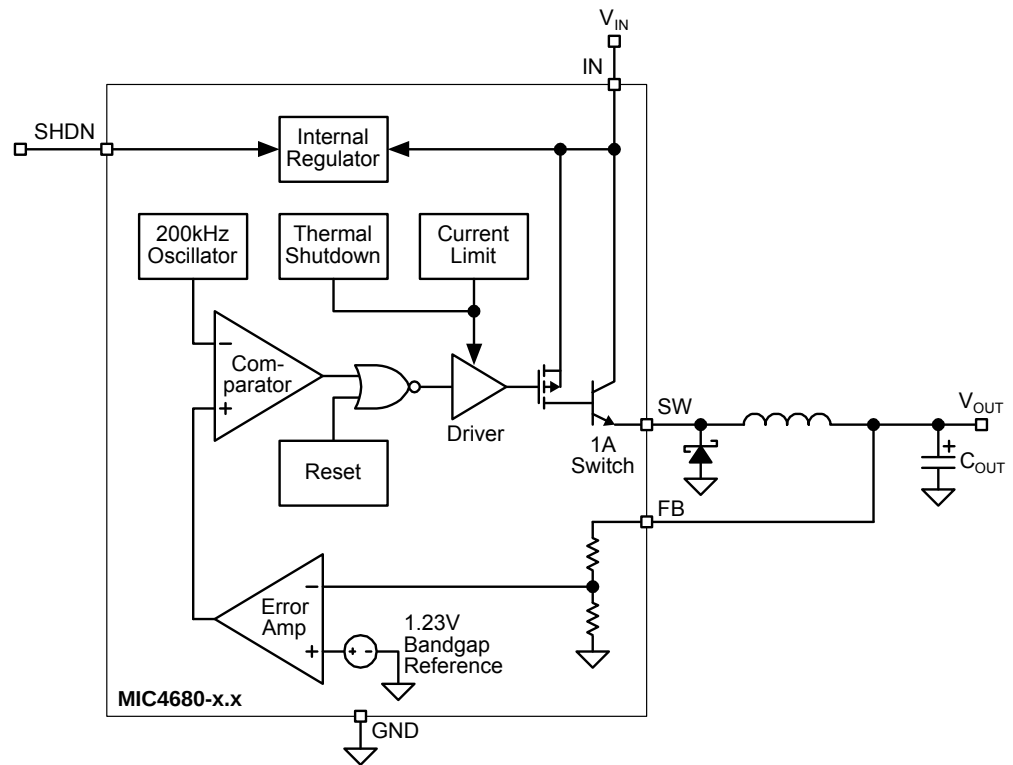


Bode Plots

The following bode plots show that the MIC4680 is stable over all conditions using a **68 μ F inductor (L)** and a **220 μ F output capacitor (C_{OUT})**. To assure stability, it is a good practice to maintain a phase margin of greater than 35°.



Functional Diagrams



Functional Description

The MIC4680 is a variable duty cycle switch-mode regulator with an internal power switch. Refer to the block diagrams.

Supply Voltage

The MIC4680 operates from a +4V to +34V unregulated input. Highest efficiency operation is from a supply voltage around +15V. See the efficiency curves.

Enable/Shutdown

The shutdown (SHDN) input is TTL compatible. Ground the input if unused. A logic-low enables the regulator. A logic-high shuts down the internal regulator which reduces the current to typically 1.5 μ A when $V_{SHDN} = V_{IN}$ = 12V and 30 μ A when $V_{SHDN} = 5$ V. See "Shutdown Input Behavior: Shutdown Hysteresis."

Feedback

Fixed-voltage versions of the regulator have an internal resistive divider from the feedback (FB) pin. Connect FB directly to the output voltage.

Adjustable versions require an external resistive voltage divider from the output voltage to ground, center tapped to the FB pin. See Figure 6b for recommended resistor values

Duty Cycle Control

A fixed-gain error amplifier compares the feedback signal with a 1.23V bandgap voltage reference. The resulting error amplifier output voltage is compared to a 200kHz sawtooth waveform to produce a voltage controlled variable duty cycle output.

A higher feedback voltage increases the error amplifier output voltage. A higher error amplifier voltage (comparator inverting input) causes the comparator to detect only the peaks of the sawtooth, reducing the duty cycle of the comparator output. A lower feedback voltage increases the duty cycle. The MIC4680 uses a voltage-mode control architecture.

Output Switching

When the internal switch is on, an increasing current flows from the supply V_{IN} , through external storage inductor L1, to output capacitor C_{OUT} and the load. Energy is stored in the inductor as the current increases with time.

When the internal switch is turned off, the collapse of the magnetic field in L1 forces current to flow through fast recovery diode D1, charging C_{OUT} .

Output Capacitor

External output capacitor C_{OUT} provides stabilization and reduces ripple. See "Bode Plots" for additional information.

Return Paths

During the on portion of the cycle, the output capacitor and load currents return to the supply ground. During the off portion of the cycle, current is being supplied to the output capacitor and load by storage inductor L1, which means that D1 is part of the high-current return path.

Applications Information

Adjustable Regulators

Adjustable regulators require a 1.23V feedback signal. Recommended voltage-divider resistor values for common output voltages are included in Figure 1b.

For other voltages, the resistor values can be determined using the following formulas:

$$V_{OUT} = V_{REF} \left(\frac{R1}{R2} + 1 \right)$$
$$R1 = R2 \left(\frac{V_{OUT}}{V_{REF}} - 1 \right), R2 = \frac{R1}{\frac{V_{OUT}}{V_{REF}} - 1}$$
$$V_{REF} = 1.23V$$

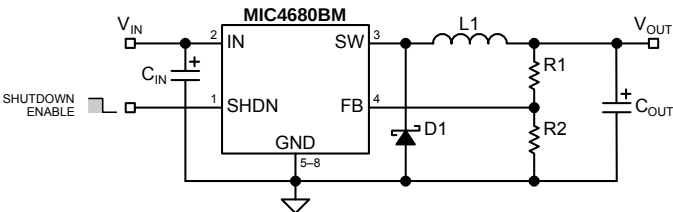


Figure 1a. Adjustable Regulator Circuit

V _{OUT}	R1*†	R2*†	C _{IN}	D1	L1	C _{OUT}
1.8V	3.01k	6.495k	15µF 35V AVX TPSE156035R0200	2A 60V Schottky B260A Vishay-Diode, Inc*** or SS26 General Semiconductor	68µH 1.5A Coiltronics UP2B-680 or Sumida CDRH125-680MC** or Sumida CDRH124-680MC**	220µF 10V AVX TPSE227010R0060
2.5V	3.01k	2.915k				
3.3V	3.01k	1.788k				
5.0V	3.01k	982Ω				
6.0V	3.01k	776Ω				

* All resistors 1%
** Shielded magnetics for low RFI applications
*** Vishay-Diode, Inc. (805) 446-48600
† Nearest available resistor values

Figure 1b. Recommended Components for Common Output Voltages

Thermal Considerations

The MIC4680 SuperSwitcher features the power-SOIC-8. This package has a standard 8-pin small-outline package profile but with much higher power dissipation than a standard SOIC-8. The MIC4680 SuperSwitcher is the first dc-to-dc converter to take full advantage of this package.

The reason that the power SOIC-8 has higher power dissipation (lower thermal resistance) is that pins 5 through 8 and the die-attach paddle are a single piece of metal. The die is attached to the paddle with thermally conductive adhesive. This provides a low thermal resistance path from the junction of the die to the ground pins. This design significantly improves package power dissipation by allowing excellent heat transfer through the ground leads to the printed circuit board.

One of the limitation of the maximum output current on any MIC4680 design is the junction-to-ambient thermal resistance (θ_{JA}) of the design (package and ground plane). Examining θ_{JA} in more detail:

$$\theta_{JA} = (\theta_{JC} + \theta_{CA})$$

where:

θ_{JC} = junction-to-case thermal resistance

θ_{CA} = case-to-ambient thermal resistance

θ_{JC} is a relatively constant 20°C/W for a power SOIC-8.

θ_{CA} is dependent on layout and is primarily governed by the connection of pins 5 through 8 to the ground plane. The purpose of the ground plane is to function as a heat sink.

θ_{JA} is ideally 63°C/W but will vary depending on the size of the ground plane to which the power SOIC-8 is attached.

Determining Ground-Plane Heat-Sink Area

There are two methods of determining the minimum ground plane area required by the MIC4680.

Quick Method

Make sure that MIC4680 pins 5 through 8 are connected to a ground plane with a minimum area of 6cm². This ground plane should be as close to the MIC4680 as possible. The area may be distributed in any shape around the package or on any pcb layer as long as there is good thermal contact to pins 5 through 8. This ground plane area is more than sufficient for most designs.

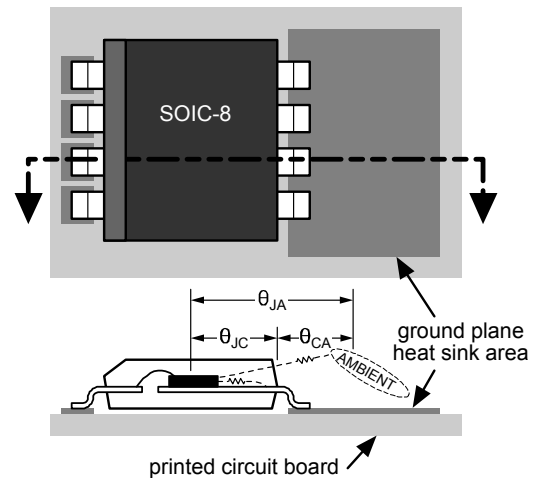


Figure 2. Power SOIC-8 Cross Section

Minimum Copper/Maximum Current Method

Using Figure 3, for a given input voltage range, determine the minimum ground-plane heat-sink area required for the application's maximum output current. Figure 3 assumes a constant die temperature of 75°C above ambient.

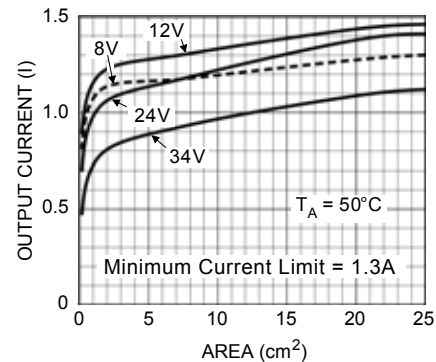


Figure 3. Output Current vs. Ground Plane Area

When designing with the MIC4680, it is a good practice to connect pins 5 through 8 to the largest ground plane that is practical for the specific design.

Checking the Maximum Junction Temperature:

For this example, with an output power (P_{OUT}) of 5W, (5V output at 1A maximum with $V_{IN} = 12V$) and 65°C maximum ambient temperature, what is the maximum junction temperature?

Referring to the "Typical Characteristics: 5V Output Efficiency" graph, read the efficiency (η) for 1A output current at $V_{IN} = 12V$ or perform you own measurement.

$$\eta = 79\%$$

The efficiency is used to determine how much of the output power (P_{OUT}) is dissipated in the regulator circuit (P_D).

$$P_D = \frac{P_{OUT}}{\eta} - P_{OUT}$$

$$P_D = \frac{5W}{0.79} - 5W$$

$$P_D = 1.33W$$

Calculate the worst-case junction temperature:

$$T_J = P_{D(IC)} \theta_{JC} + (T_C - T_A) + T_{A(max)}$$

where:

T_J = MIC4680 junction temperature

$P_{D(IC)}$ = MIC4680 power dissipation

θ_{JC} = junction-to-case thermal resistance.

The θ_{JC} for the MIC4680's power-SOIC-8 is approximately 20°C/W. (Also see Figure 1.)

T_C = "pin" temperature measurement taken at the entry point of pins 6 or 7 into the plastic package at the ambient temperature (T_A) at which T_C is measured.

T_A = ambient temperature at which T_C is measured.

$T_{A(max)}$ = maximum ambient operating temp. for the specific design.

Calculating the maximum junction temperature given a maximum ambient temperature of 65°C:

$$T_J = 1.064 \times 20^\circ\text{C/W} + (45^\circ\text{C} - 25^\circ\text{C}) + 65^\circ\text{C}$$

$$T_J = 106.3^\circ\text{C}$$

This value is less than the allowable maximum operating junction temperature of 125°C as listed in "Operating Ratings." Typical thermal shutdown is 160°C and is listed in "Electrical Characteristics."

Increasing the Maximum Output Current

The maximum output current at high input voltages can be increased for a given board layout. The additional three components shown in Figure 4 will reduce the overall loss in the MIC4680 by about 20% at high V_{IN} and high I_{OUT} .

Even higher output current can be achieved by using the MIC4680 to switch an external FET. See Figure 9 for a 5A supply with current limiting.

Layout Considerations

Layout is very important when designing any switching regulator. Rapidly changing switching currents through the printed circuit board traces and stray inductance can generate voltage transients which can cause problems.

To minimize stray inductance and ground loops, keep trace lengths, indicated by the heavy lines in Figure 5, as short as possible. For example, keep D1 close to pin 3 and pins 5 through 8, keep L1 away from sensitive node FB, and keep C_{IN} close to pin 2 and pins 5 through 8. See "Applications Information: Thermal Considerations" for ground plane layout.

The feedback pin should be kept as far away from the switching elements (usually L1 and D1) as possible.

A circuit with sample layouts is provided. See Figure 6a through 6e.

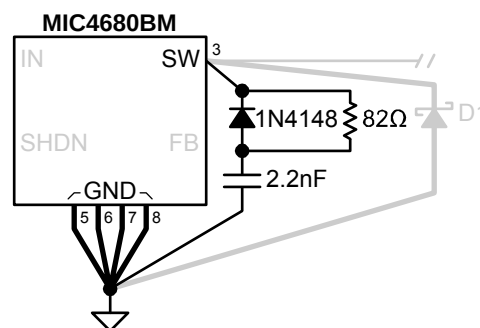


Figure 4. Increasing Maximum Output Current at High Input Voltages

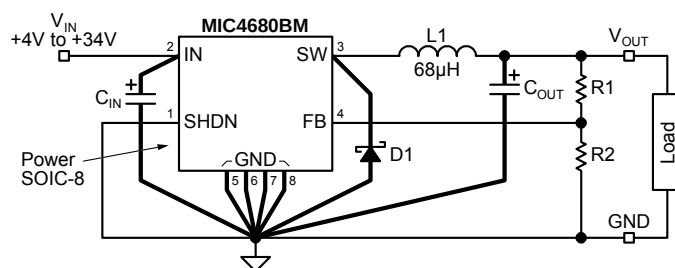


Figure 5. Critical Traces for Layout

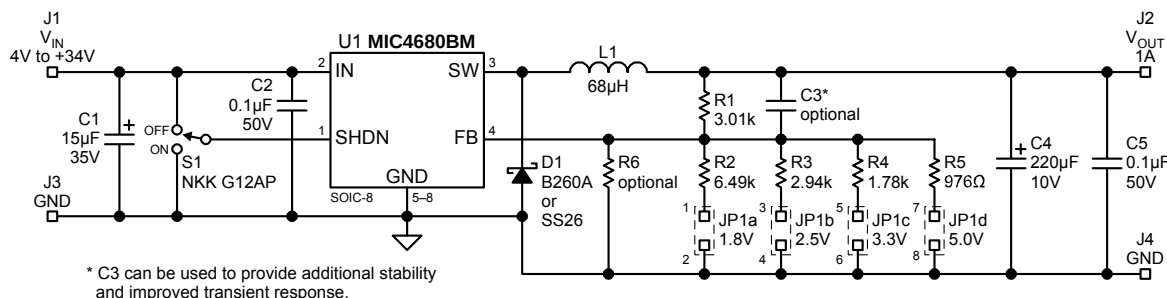


Figure 6a. Evaluation Board Schematic Diagram

Printed Circuit Board Layouts

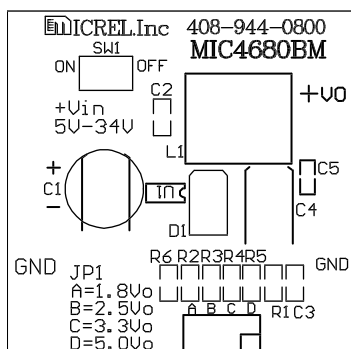


Figure 6b. Top-Side Silk Screen

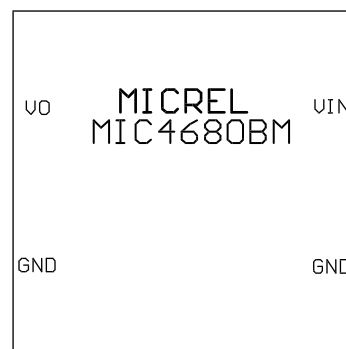


Figure 6d. Bottom-Side Silk Screen

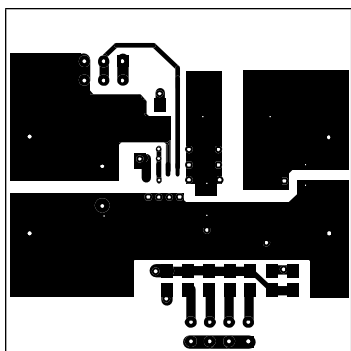


Figure 6c. Top-Side Copper

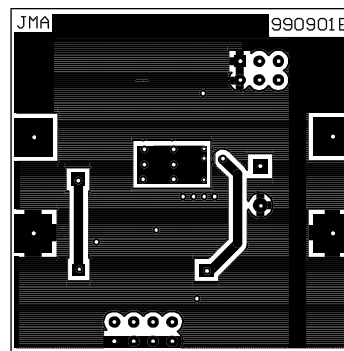


Figure 6e. Bottom-Side Copper

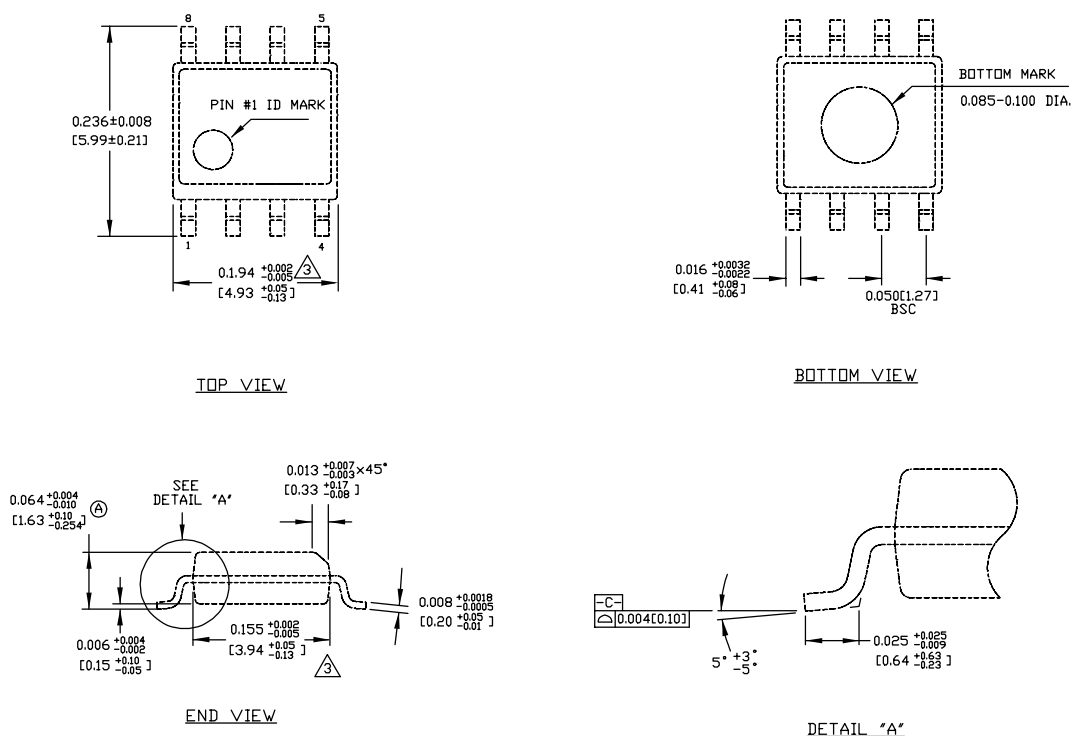
Abbreviated Bill of Materials (Critical Components)

Reference	Part Number	Manufacturer	Description	Qty.
C1	TPSD156M035R0300	AVX ¹	15μF 35V	1
	ECE-A1HFS470	Panasonic ²	47μF 50V, 8mm × 11.5mm	
C4	TPSD227M010R0150	AVX	220μF 10V	1
D1	B260A	Vishay-Diodes, Inc. ³	Schottky	1
	SS26	General Semiconductor		
L1	UP2B-680	Coiltronics ⁴	68μH, 1.5A, nonshielded	1
	CDH115-680MC	Sumida ⁵	68μH, 1.5A, nonshielded	
	CDRH124-680MC	Sumida	68μH, 1.5A, shielded	
U1	MIC4680BM	Micrel ⁽⁶⁾	1A 200kHz power-SO-8 buck regulator	1

Notes:

1. AVX: www.avxcorp.com2. Panasonic: www.maco.panasonic.co.jp/eccd/index.html3. Vishay-Diodes, Inc.: www.diodes.com4. Coiltronics: www.coiltronics.com5. Sumida: www.sumida.com6. Micrel, Inc.: www.micrel.com

Package Information



NOTES:

1. DIMENSIONS ARE IN INCHES[MM].
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.010[0.25] PER SIDE.

8-Pin SOIC (M)

MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA

TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB <http://www.micrel.com>

The information furnished by Micrel in this data sheet is believed to be accurate and reliable. However, no responsibility is assumed by Micrel for its use. Micrel reserves the right to change circuitry and specifications at any time without notification to the customer.

Micrel Products are not designed or authorized for use as components in life support appliances, devices or systems where malfunction of a product can reasonably be expected to result in personal injury. Life support devices or systems are devices or systems that (a) are intended for surgical implant into the body or (b) support or sustain life, and whose failure to perform can be reasonably expected to result in a significant injury to the user. A Purchaser's use or sale of Micrel Products for use in life support appliances, devices or systems is a Purchaser's own risk and Purchaser agrees to fully indemnify Micrel for any damages resulting from such use or sale.

© 2000 Micrel, Incorporated.